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(12) **United States Design Patent** (10) **Patent No.:** **US D516,047 S**
Hahn et al. (45) **Date of Patent:** **** Feb. 28, 2006**

(54) **MODULAR ELECTRONIC HOUSING AND ASSEMBLIES**

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(75) Inventors: **Amand J. Hahn**, Lansdale, PA (US);
Rod P. Boer, Hartboro, PA (US); **Eric A. Schneider**, Erdenheim, PA (US)

* cited by examiner

(73) Assignee: **Honeywell International Inc.**,
Morristown, NJ (US)

Primary Examiner—Prabhakar Deshmukh
Assistant Examiner—Selina Sikder
(74) *Attorney, Agent, or Firm*—Anthony Mioloqos

(**) Term: **14 Years**

(57) **CLAIM**

(21) Appl. No.: **29/233,208**

The ornamental design for a modular electronic housing and assemblies, as shown and described.

(22) Filed: **Jun. 28, 2005**

Related U.S. Application Data

DESCRIPTION

(62) Division of application No. 29/195,922, filed on Dec. 18, 2003, now Pat. No. Des. 499,567.

The modular electronic housing and assemblies comprise an assembly of modular electronic housings intended to be used to house electronic circuit boards and their included electronic components.

(51) **LOC (8) Cl.** **13-03**

(52) **U.S. Cl.** **D13/184**

(58) **Field of Classification Search** D13/184;
D14/240; 174/50, 52.1; 220/4.02; 361/600,
361/601, 679, 688, 704, 724, 796

The FIGURE is a right side perspective view of a modular electronic housing and assemblies showing our new design.

See application file for complete search history.

The broken line disclosure in the drawings are for illustrative purposes only and form no part of the claimed design.

(56) **References Cited**

U.S. PATENT DOCUMENTS

1 Claim, 1 Drawing Sheet

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